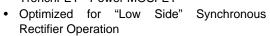


N-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A) ^d	Q _g (Typ.)			
60	0.012 at V _{GS} = 10 V	12	10.5 nC			
00	0.015 at V _{GS} = 4.5 V	11	10.5110			

FEATURES • Halogen-free According to IEC 61249-2-21 Definition

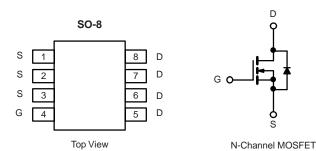




100 % R_g and UIS Tested



ROHS COMPLIANT HALOGEN FREE



APPLICATIONS

CCFL Inverter

ABSOLUTE MAXIMUM RATINGS T_A	= 25 °C, unless other	erwise noted		
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	60	V	
Gate-Source Voltage	V _{GS}	± 20	V	
	T _C = 25 °C		12 ^a	
Continuous Drain Current (T _J = 150 °C)	T _C = 70 °C] [11	
Continuous Diam Curient (1) = 130 C)	T _A = 25 °C	- I _D -	8.0 ^{b, c}	
	T _A = 70 °C	1	7.6 ^{b, c}	A
Pulsed Drain Current	I _{DM}	25	_ ^	
Continuous Source-Drain Diode Current	T _C = 25 °C	l-	4.2	
Continuous Source-Diain Diode Current	T _A = 25 °C	- Is	2.1 ^{b, c}	
Avalanche Current	L = 0.1 mH	I _{AS}	15	
Single-Pulse Avalanche Energy		E _{AS}	11.2	mJ
	T _C = 25 °C		5	
Mayimum Dayyar Dissination	T _C = 70 °C	$\begin{bmatrix} \\ P_D \end{bmatrix}$	3.2	w
Maximum Power Dissipation	T _A = 25 °C		2.5 ^{b, c}	VV
	T _A = 70 °C] [1.6 ^{b, c}	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	38	50	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	20	25	- C/VV	

Notes:

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under Steady State conditions is 85 °C/W.



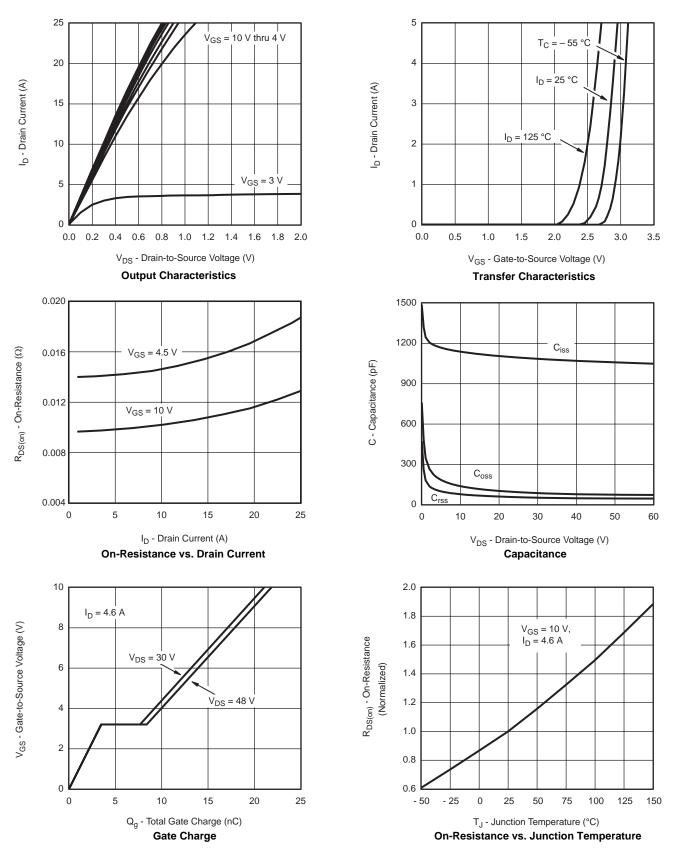
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	60			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$			55		mV/°C
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	$I_{D} = 250 \mu\text{A}$		- 6.3		IIIV/ C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.0		3.0	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zoro Gato Voltago Drain Current	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V			1 ,,,	
Zero Gate Voltage Drain Current		V _{DS} = 60 V, V _{GS} = 0 V, T _J = 55 °C			10	μA
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	25			Α
Dunin Course On State Benistance	P	$V_{GS} = 10 \text{ V}, I_D = 4.6 \text{ A}$		0.012		
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 4.2 \text{ A}$		0.015		Ω
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 4.6 A		20		S
Dynamic ^b						•
Input Capacitance	C _{iss}			1100		pF
Output Capacitance	C _{oss}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		90		
Reverse Transfer Capacitance	C _{rss}			55		
Total Cata Charga		$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 4.6 \text{ A}$		21	32	
Total Gate Charge	Q_g			10.5	16	nC
Gate-Source Charge	Q _{gs}	$V_{DS} = 30 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 4.6 \text{ A}$		3.5		110
Gate-Drain Charge	Q _{gd}			4.2		
Gate Resistance	R_g	f = 1 MHz		3.3	5	Ω
Turn-On Delay Time	t _{d(on)}			20	30	
Rise Time	t _r	$V_{DD} = 30 \text{ V, R}_{L} = 5.4 \Omega$		150	225	
Turn-Off DelayTime	t _{d(off)}	$I_D \cong 5.6 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		20	30	
Fall Time	t _f			60	90	
Turn-On Delay Time	t _{d(on)}			10	15	ns
Rise Time	t _r	$V_{DD} = 30 \text{ V}, R_{L} = 5.4 \Omega$		15	25	
Turn-Off DelayTime	t _{d(off)}	$I_D \cong 5.6 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		25	40	
Fall Time	t _f			10	15	
Drain-Source Body Diode Characterist	ics			•	•	
Continous Source-Drain Diode Current	I _S	T _C = 25 °C			4.2	^
Pulse Diode Forward Current ^a	I _{SM}				25	Α
Body Diode Voltage	V _{SD}	I _S = 2 A		0.8	1.2	V
Body Diode Reverse Recovery Time	t _{rr}			25	50	ns
Body Diode Reverse Recovery Charge	Q _{rr}	1 _ E E A dl/dt _ 100 A/v = T		25	50	nC
Reverse Recovery Fall Time	t _a	In = 0.0 A. 01/01 = 100 A/US. 1 = 20 °C		19		20
Reverse Recovery Rise Time	t _b			6		ns

Notes:

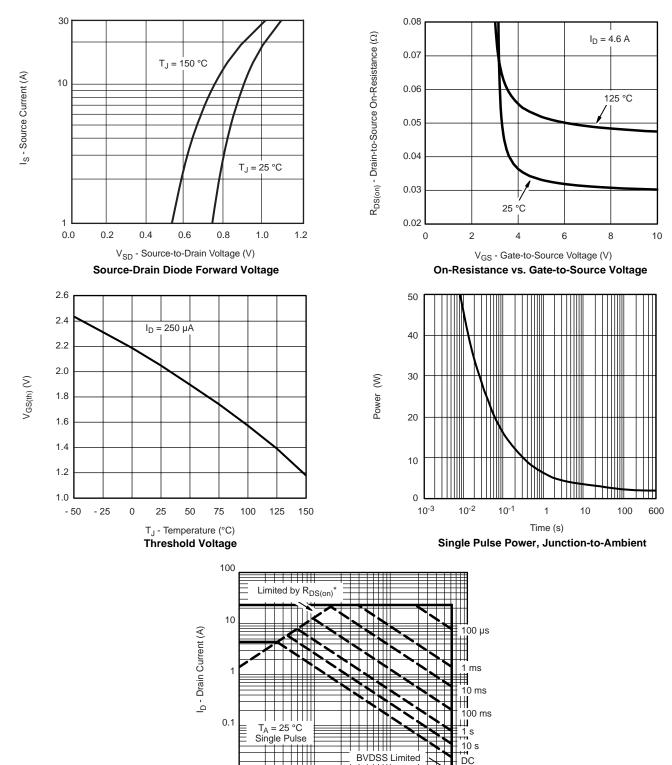
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.









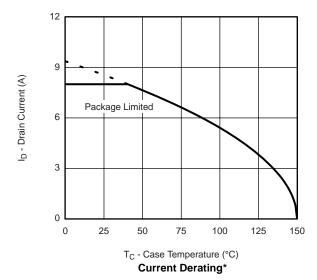
* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified **Safe Operating Area**

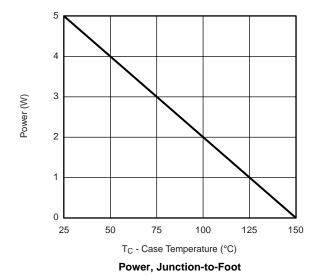
V_{DS} - Drain-to-Source Voltage (V)

100

0.01

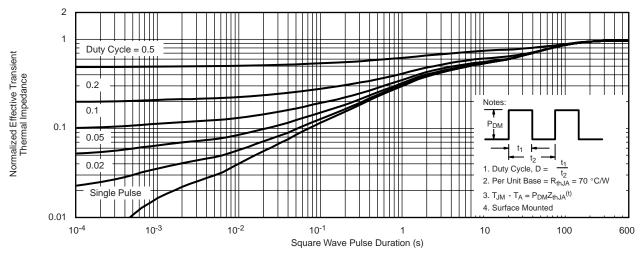




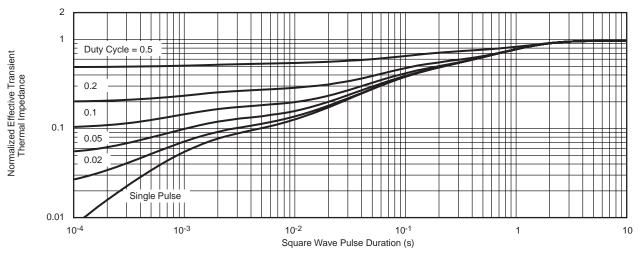


^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

服务热线:400-655-8788

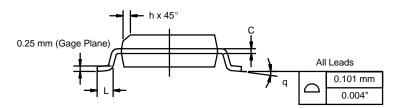
6



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







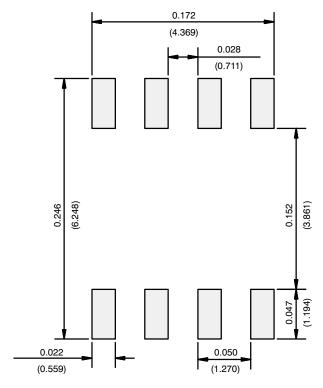
	MILLIMETERS INCHES			HES		
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Pey L 11-Sep-06						

ECN: C-06527-Rev. I, 11-Sep-06

DWG: 5498



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)



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